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## CYLINDRICAL TYPE LED LAMPS

**LY4630**

## DATA SHEET

DOC. NO : QW0905-LY4630

REV. : A

DATE : 26 - Dec. - 2005



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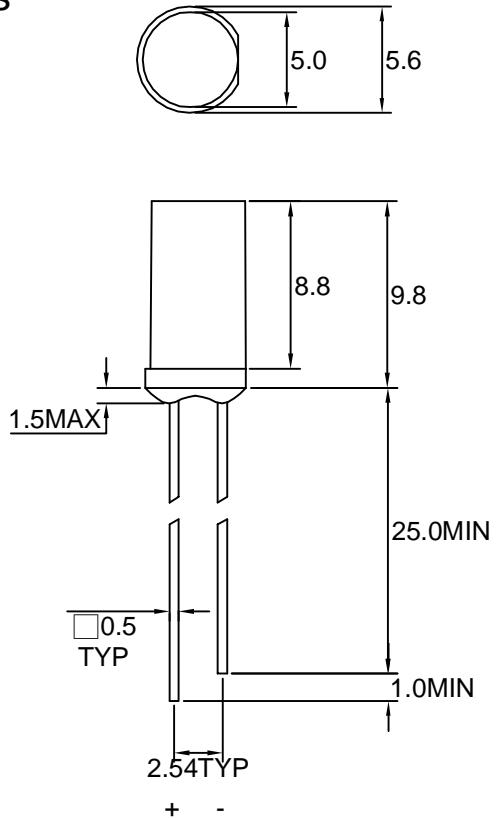
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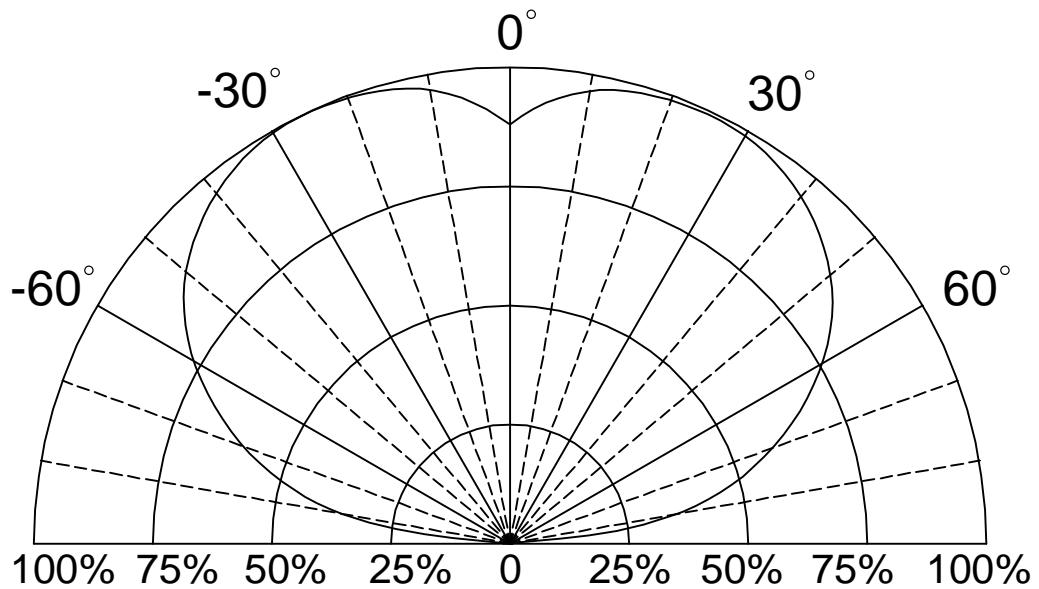
### Package Dimensions



Note : 1. All dimension are in millimeter tolerance is  $\pm 0.25\text{mm}$  unless otherwise noted.

2. Specifications are subject to change without notice.

### Directivity Radiation





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## Absolute Maximum Ratings at Ta=25 °C

Parameter	Symbol	Ratings		<b>UNIT</b>
		Y		
Forward Current	IF	20		mA
Peak Forward Current Duty 1/10@10KHz	IFP	80		mA
Power Dissipation	PD	60		mW
Reverse Current @5V	Ir	10		µA
Operating Temperature	T <sub>opr</sub>	-40 ~ +85		°C
Storage Temperature	T <sub>stg</sub>	-40 ~ +100		°C
Soldering Temperature	T <sub>sol</sub>	Max 260 °C for 5 sec Max (2mm from body)		

## Typical Electrical &amp; Optical Characteristics (Ta=25 °C)

PART NO	MATERIAL	COLOR		Peak wave length $\lambda$ Pnm	Spectral halfwidth $\Delta \lambda$ nm	Forward voltage @20mA(V)		Luminous intensity @10mA(mcd)		Viewing angle 2θ 1/2 (deg)
		Emitted	Lens			Min.	Max.	Min.	Typ.	
LY4630	GaAsP/GaP	Yellow	Yellow Diffused	585	35	1.7	2.6	8.0	14.0	144

Note : 1.The forward voltage data did not including ±0.1V testing tolerance.  
 2. The luminous intensity data did not including ±15% testing tolerance.



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## Typical Electro-Optical Characteristics Curve

Y CHIP

Fig.1 Forward current vs. Forward Voltage

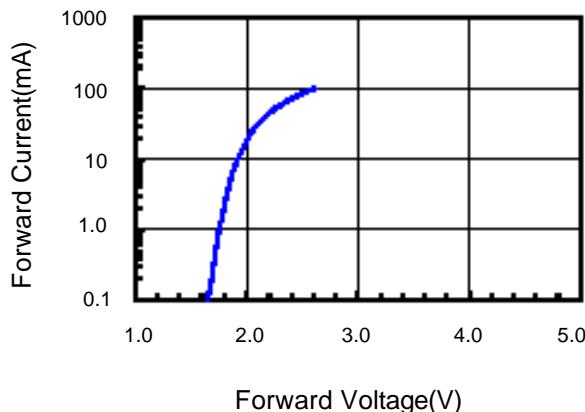


Fig.2 Relative Intensity vs. Forward Current

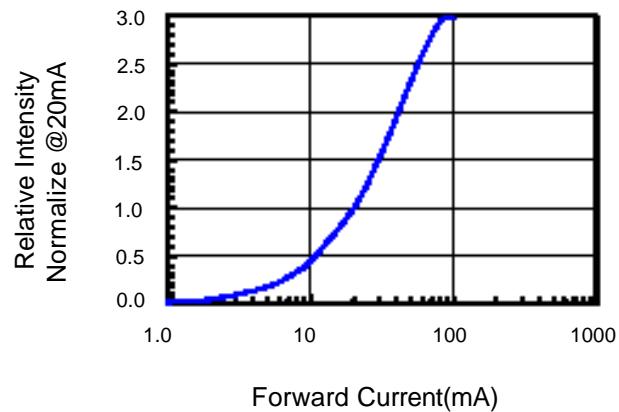


Fig.3 Forward Voltage vs. Temperature

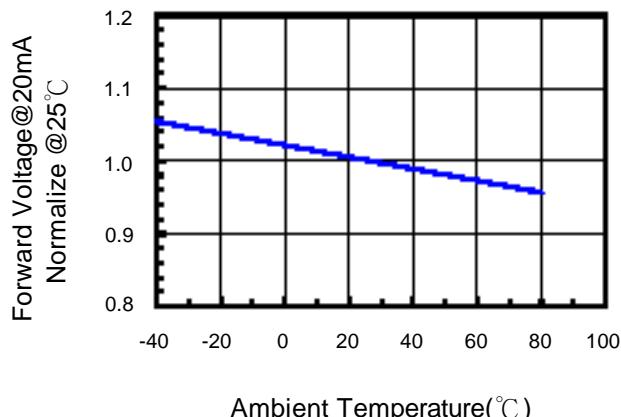


Fig.4 Relative Intensity vs. Temperature

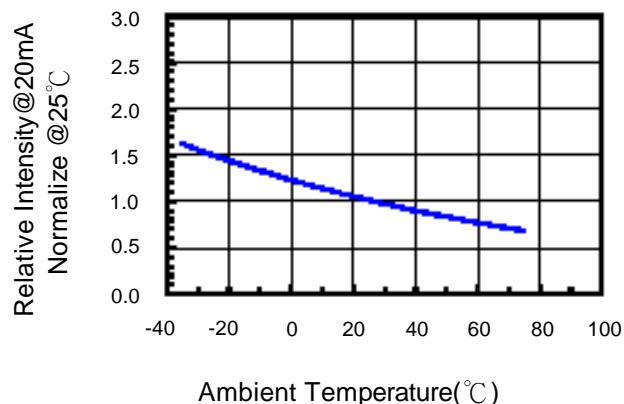
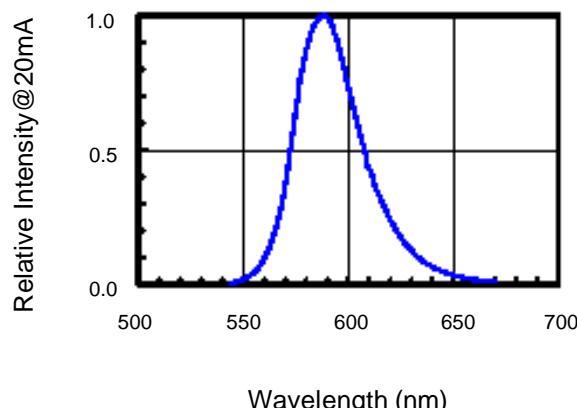


Fig.5 Relative Intensity vs. Wavelength





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## Reliability Test:

Test Item	Test Condition	Description	Reference Standard
Operating Life Test	1.Under Room Temperature 2.If=20mA 3.t=1000 hrs (-24hrs, +72hrs)	This test is conducted for the purpose of determining the resistance of a part in electrical and thermal stressed.	MIL-STD-750: 1026 MIL-STD-883: 1005 JIS C 7021: B-1
High Temperature Storage Test	1.Ta=105 °C±5°C 2.t=1000 hrs (-24hrs, +72hrs)	The purpose of this is the resistance of the device which is laid under condition of high temperature for hours.	MIL-STD-883:1008 JIS C 7021: B-10
Low Temperature Storage Test	1.Ta=-40 °C±5°C 2.t=1000 hrs (-24hrs, +72hrs)	The purpose of this is the resistance of the device which is laid under condition of low temperature for hours.	JIS C 7021: B-12
High Temperature High Humidity Test	1.Ta=65 °C±5°C 2.RH=90%~95% 3.t=240hrs ±2hrs	The purpose of this test is the resistance of the device under tropical for hours.	MIL-STD-202:103B JIS C 7021: B-11
Thermal Shock Test	1.Ta=105 °C±5°C &-40 °C±5°C (10min) (10min) 2.total 10 cycles	The purpose of this is the resistance of the device to sudden extreme changes in high and low temperature.	MIL-STD-202: 107D MIL-STD-750: 1051 MIL-STD-883: 1011
Solder Resistance Test	1.T.Sol=260 °C±5°C 2.Dwell time= 10 ±1sec.	This test intended to determine the thermal characteristic resistance of the device to sudden exposures at extreme changes in temperature when soldering the lead wire.	MIL-STD-202: 210A MIL-STD-750: 2031 JIS C 7021: A-1
Solderability Test	1.T.Sol=230 °C±5°C 2.Dwell time=5 ±1sec	This test intended to see soldering well performed or not.	MIL-STD-202: 208D MIL-STD-750: 2026 MIL-STD-883: 2003 JIS C 7021: A-2